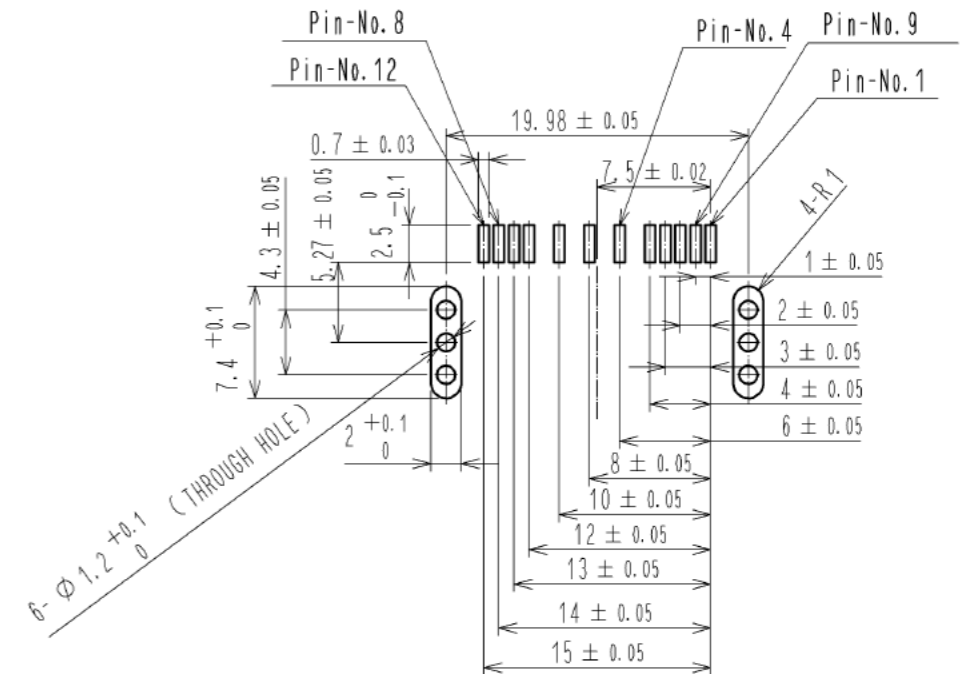
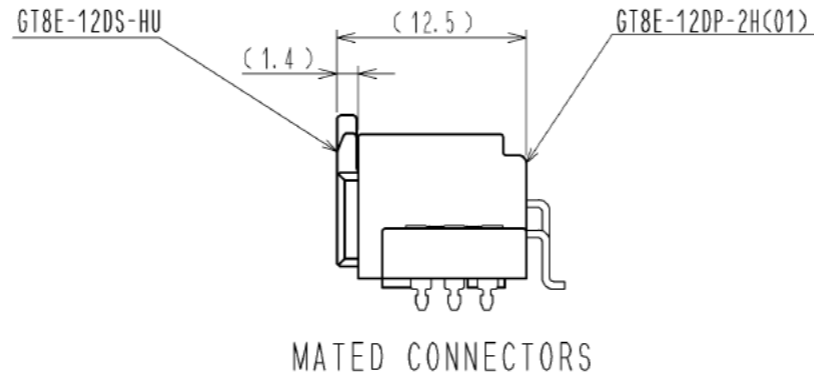
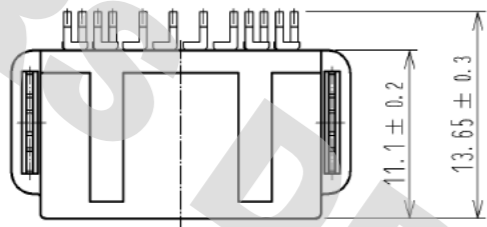
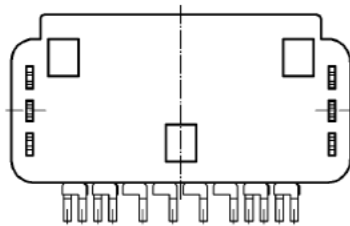
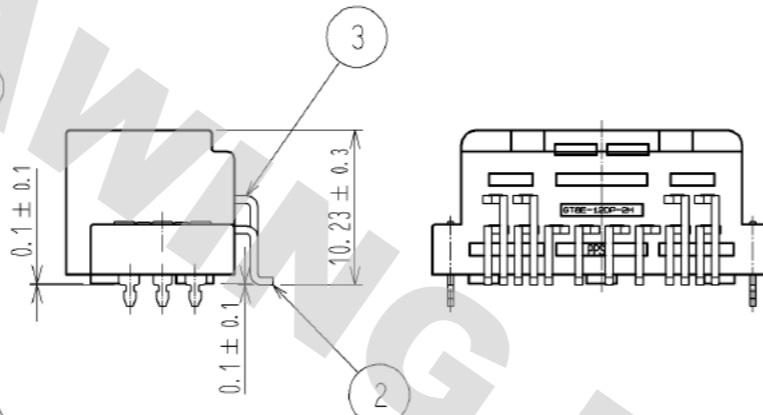
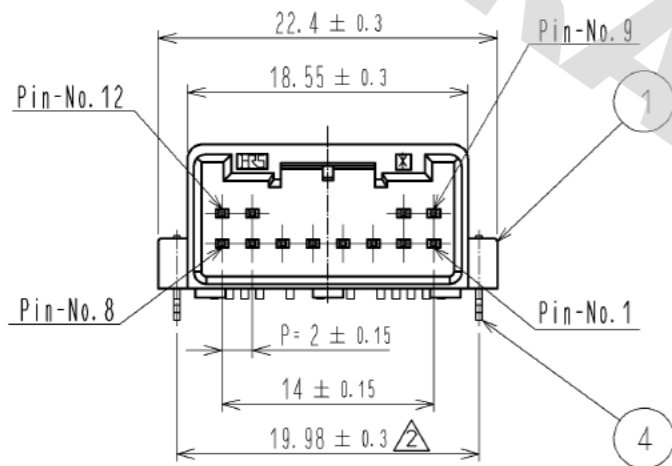


ELV. RoHS COMPLIANT

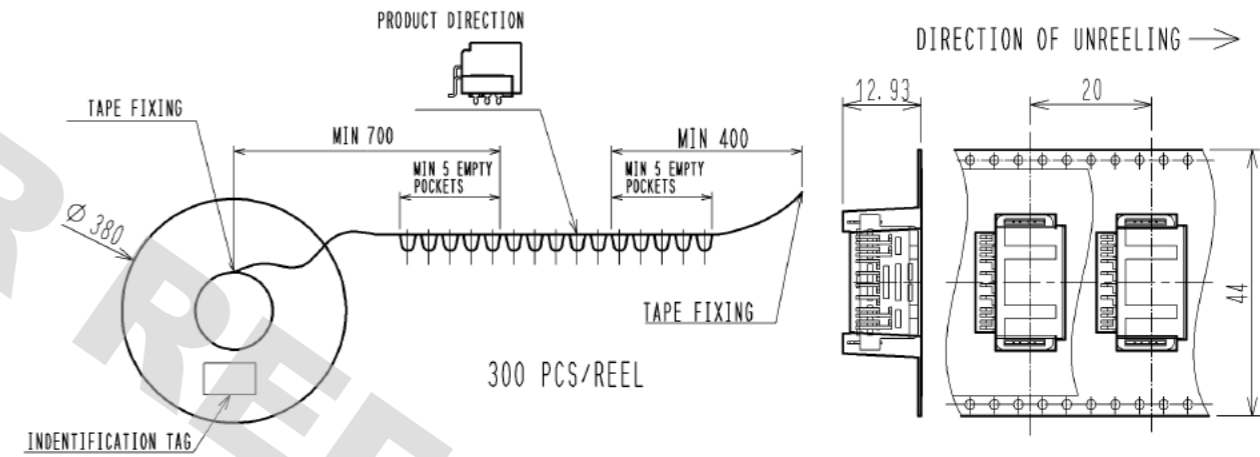


RECOMMENDED PC BOARD PATTERN (CONNECTOR SIDE)



EMBOSS PACKING SPECIFICATIONS(FREE)

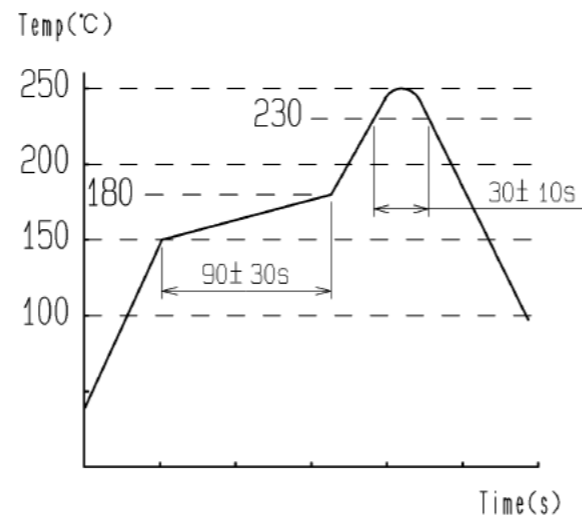
1. PLACE CONNECTORS INTO EMBOSSED CARRIER TAPE.



2. PUT A REEL INTO CARTON BOX

W = (405) (mm)
D = (405) (mm)
H = (51) (mm)

- NOTE1. RECOMMENDED TEMPERATURE PROFILE FOR REFLOW (REFER TO RIGHT FIG.)
USED REFLOW SYSTEM : IR IN THE AIR OR NITROGEN
NO. OF CYCLES : 2 MAX
PEAK : 250°C
OVER 230°C : 20~40s
PREHEAT : 150~180°C (60~120s)
- NOTE2. TEMPERATURE FOR SOLDERING IRON : 280~300°C WITHIN 2s
- NOTE3. CO-PLANARITY SHALL BE 0.1 MAX
- NOTE4. PC BOARD THICKNESS=1.6
- NOTE5. RECOMMENDED SOLDER THICKNESS=0.15



2	BRASS	TIN AND GOLD PLATING	4	BRASS	TIN PLATING
1	PPS	BLACK	3	BRASS	TIN AND GOLD PLATING
NO.	MATERIAL	FINISH . REMARKS	NO.	MATERIAL	FINISH . REMARKS
UNITS mm	SCALE 2 : 1	COUNT 1	DESCRIPTION OF REVISIONS DIS-T-003270	DESIGNED RZ. KANO	CHECKED HS. OZAWA
APPROVED : AR. SHIRAI		12.12.07		DRAWING NO. EDC3-167884-01	
CHECKED : NH. NAKATA		12.12.07		PART NO. GT8E-12DP-2H(01)	
DESIGNED : RZ. KANO		12.12.06		CODE NO. CL758-1008-2-01	
DRAWN : RZ. KANO		12.12.06		DATE 13.04.17	

DRAWING FOR REFERENCE: This is subject to change without notice
05/31/2013

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[Hirose Electric:](#)

[GT8E-12DP-2H\(01\)](#)